

STF10N80K5, **STFU10N80K5**

N-channel 800 V, 0.470 Ω typ., 9 A MDmesh™ K5 Power MOSFETs in a TO-220FP and TO-220FP ultra narrow leads

Datasheet - production data

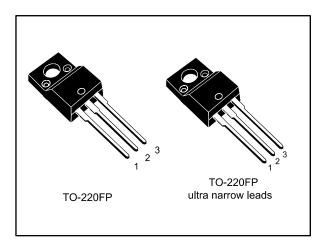
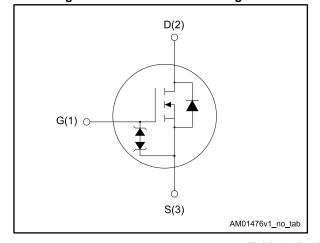


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	ΙD	Ртот
STF10N80K5	800 V	0.600 Ω	9 A	30 W
STFU10N80K5	800 V			30 W

- Industry's lowest R_{DS(on)} x area
- Industry's best figure of merit (FoM)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

These very high voltage N-channel Power MOSFETs are designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STF10N80K5	10N80K5	TO-220FP	Tube
STFU10N80K5	CADONIUI	TO-220FP ultra narrow leads	rube

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Contents

1	Electric	al ratings	3
2	Electric	al characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	cuits	9
4	Packag	e information	11
	4.1	TO-220FP package information	12
	4.2	TO-220FP ultra narrow leads package information	14
5	Revisio	n history	16



1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	± 30	V
I _D ⁽¹⁾	Drain current (continuous) at T _C = 25 °C	9	Α
I _D ⁽¹⁾	Drain current (continuous) at T _C = 100 °C	6	Α
I _{DM} ⁽²⁾	Drain current pulsed	36	Α
P _{TOT}	Total dissipation at T _C = 25 °C	30	W
I _{AR}	Max. current during repetitive or single pulse avalanche (pulse width limited by $T_{\text{jmax.}}$)	3	Α
Eas	Single pulse avalanche energy (starting $T_J = 25$ °C, $I_D = I_{AS}$, $V_{DD} = 50$ V)	130	mJ
V _{ISO}	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; T_C = 25 °C)	2500	V
dv/dt (3)	Peak diode recovery voltage slope	4.5	\
dv/dt (4)	MOSFET dv/dt ruggedness	50	V/ns
Tj	Operating junction temperature range	55 to 450	°C
T _{stg}	Storage temperature range	- 55 to 150	<u>-</u> -C

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	4.2	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	62.5	°C/W

 $^{^{(1)}}$ Limited by maximum junction temperature.

⁽²⁾Pulse width limited by safe operating area.

 $^{^{(3)}}I_{SD} \le 9$ A, di/dt ≤ 100 A/ μ s; V_{DS} peak $\le V_{(BR)DSS}$

 $^{^{(4)}}V_{DS} \le 640 \text{ V}$

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 4: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	800			٧
		V _{GS} = 0 V, V _{DS} = 800 V			1	μΑ
IDSS	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$ $T_{C} = 125 ^{\circ}\text{C}^{(1)}$			50	μΑ
I _{GSS}	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}$, $I_D = 100 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 4.5 \text{ A}$		0.470	0.600	Ω

Notes:

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	635	1	pF
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	53	ı	pF
C _{rss}	Reverse transfer capacitance	V _{GS} = 0 V		0.8	1	pF
C _{o(tr)} ⁽¹⁾	Equivalent capacitance time related	V 0 to 640 V V 0 V	-	85	ı	pF
C _{o(er)} ⁽²⁾	Equivalent capacitance energy related	V _{DS} = 0 to 640 V, V _{GS} = 0 V		34	ı	pF
Rg	Intrinsic gate resistance	$f = 1 \text{ MHz}$, $I_D = 0 \text{ A}$	-	6	ı	Ω
Q_g	Total gate charge	$V_{DD} = 640 \text{ V}, I_{D} = 9 \text{ A}$	-	22	ı	nC
Qgs	Gate-source charge	V _{GS} = 10 V	-	5.5	-	nC
Q _{gd}	Gate-drain charge	See Figure 16: "Test circuit for gate charge behavior"	-	13.2	-	nC

Notes:

47/

⁽¹⁾Defined by design, no subject to production test.

 $^{^{(1)}}$ Time related is defined as a constant equivalent capacitance giving the same charging time as Coss when V_{DS} increases from 0 to 80% V_{DSS} .

 $^{^{(2)}}$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as Coss when V_{DS} increases from 0 to 80% V_{DSS} .

Table 6: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	V _{DD} = 400 V, I _D = 4.5 A, R _G = 4.7 Ω V _{GS} = 10 V See Figure 15: "Test circuit for resistive load switching times" and Figure 20: "Switching time waveform"	-	14.5	-	ns
tr	Rise time		1	11	1	ns
$t_{\text{d(off)}}$	Turn-off delay time			35	1	ns
t f	Fall time		-	14	-	ns

Table 7: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		9	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		36	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 9 A, V _{GS} = 0 V	-		1.5	V
t _{rr}	Reverse recovery time	I _{SD} = 9 A, di/dt = 100 A/µs,	1	370		ns
Qrr	Reverse recovery charge	V _{DD} = 60 V, see Figure 17: "Test circuit for inductive load switching and diode recovery times")	-	4.58		μC
I _{RRM}	Reverse recovery current		-	25		Α
t _{rr}	Reverse recovery time	I _{SD} = 9 A, di/dt = 100 A/μs, V _{DD} = 60 V, T _j = 150 °C see Figure 17: "Test circuit for inductive load switching and diode recovery times"	-	520		ns
Qrr	Reverse recovery charge		-	5.88		μC
I _{RRM}	Reverse recovery current		-	22.5		А

Notes:

Table 8: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
V (BR)GSO	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_{D} = 0 \text{ A}$	30	-	-	V

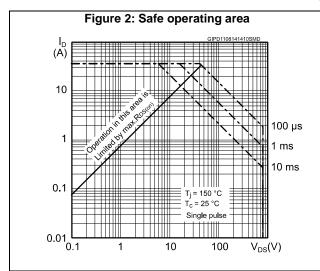
The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.



⁽¹⁾Pulse width limited by safe operating area.

 $^{^{(2)}}$ Pulsed: pulse duration = 300 μ s, duty cycle 1.5%.

2.1 Electrical characteristics (curves)



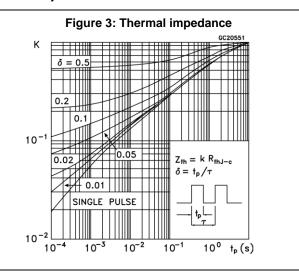


Figure 4: Output characteristics

ID(A)

VGS=11 V

10 V

9 V

16

12

8 V

6 V

00

4 8 12 16 VDS(V)

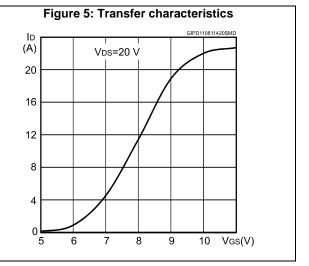
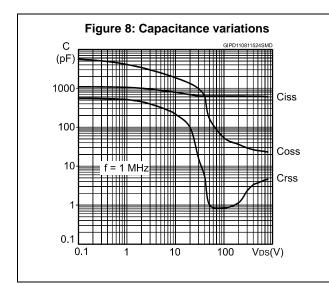
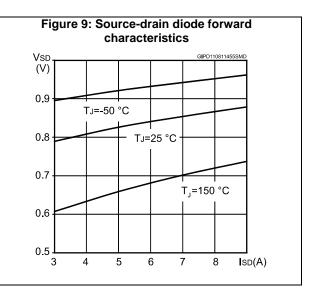
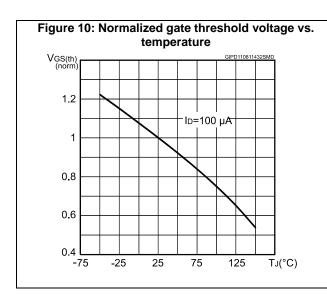
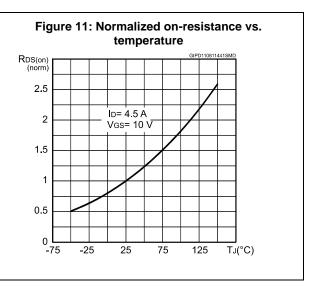


Figure 6: Gate charge vs. gate-source voltage VDS 600 12 500 10 8 400 6 300 Vps= 640 V 200 ID= 9 A 2 100 12 8 16 20 Qg(nC)

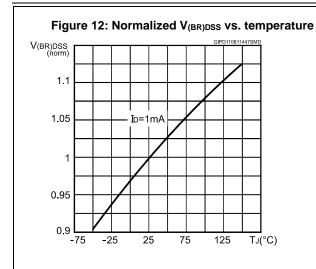


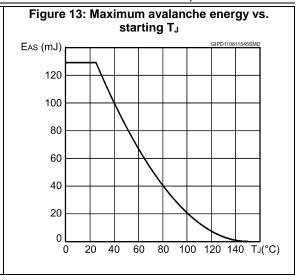


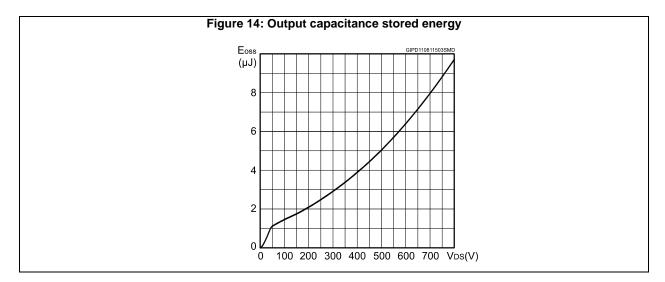












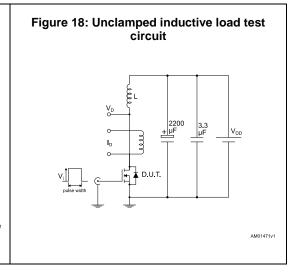
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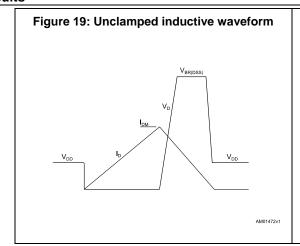
3 Test circuits

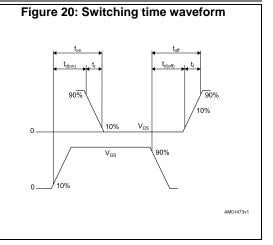
Figure 15: Test circuit for resistive load switching times

switching and diode recovery times

Figure 17: Test circuit for inductive load







10/17

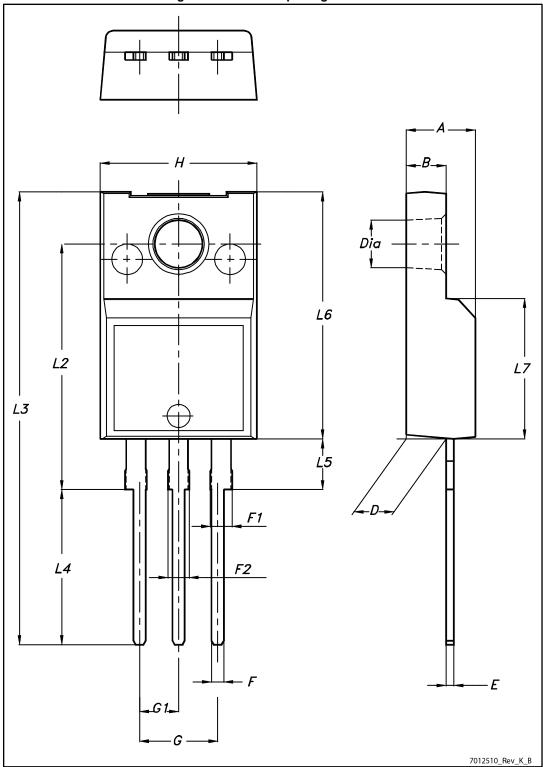
4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.



4.1 TO-220FP package information

Figure 21: TO-220FP package outline



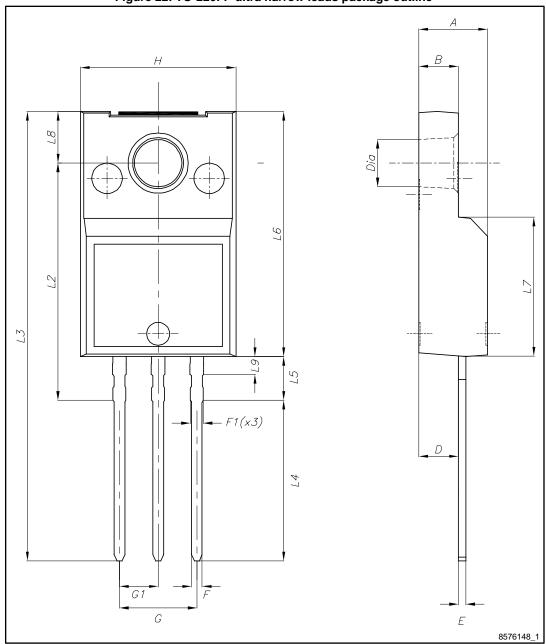
57/

Table 9: TO-220FP package mechanical data

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Dim.		mm			
Dim.	Min.	Тур.	Max.		
A	4.4		4.6		
В	2.5		2.7		
D	2.5		2.75		
E	0.45		0.7		
F	0.75		1		
F1	1.15		1.70		
F2	1.15		1.70		
G	4.95		5.2		
G1	2.4		2.7		
Н	10		10.4		
L2		16			
L3	28.6		30.6		
L4	9.8		10.6		
L5	2.9		3.6		
L6	15.9		16.4		
L7	9		9.3		
Dia	3		3.2		

4.2 TO-220FP ultra narrow leads package information

Figure 22: TO-220FP ultra narrow leads package outline



577

Table 10: TO-220FP ultra narrow leads mechanical data

Dim	mm				
Dim.	Min.	Тур.	Max.		
А	4.40		4.60		
В	2.50		2.70		
D	2.50		2.75		
Е	0.45		0.60		
F	0.65		0.75		
F1	-		0.90		
G	4.95		5.20		
G1	2.40	2.54	2.70		
Н	10.00		10.40		
L2	15.10		15.90		
L3	28.50		30.50		
L4	10.20		11.00		
L5	2.50		3.10		
L6	15.60		16.40		
L7	9.00		9.30		
L8	3.20		3.60		
L9	-		1.30		
Dia.	3.00		3.20		

5 Revision history

Table 11: Document revision history

Date	Revision	Changes
23-Jun-2014	1	First release.
13-Aug-2014	2	-Document status promoted from preliminary to production dataInserted Section 3: Electrical characteristics (curves)Minor text changes.
17-Sep-2014	3	Updated title, features and description in cover page.
05-Nov-2014	4	Updated Section 3: Electrical characteristics (curves). Minor text changes.
08-Sep-2016	5	Added the order code STFU10N80K5 and the relative Section 4.2: "TO-220FP ultra narrow leads package information".



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